

A/D 581-40

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RECORDATION FORM
COVER SHEET
PATENTS

Atty. Docket: FR030044US1

JC 20 Rec'd PCT/PTO 21 OCT 2005

10.21.05

To the Honorable Commissioner of Patents and Trademarks:
Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):

REBHA EL-FARHANE

2. Name and address of receiving party(ies)

KONINKLIJKE PHILIPS ELECTRONICS N.V.
Groenewoudseweg 1
Eindhoven, The Netherlands 5621 BA

3. Nature of conveyance:

- Assignment Merger
- Security Agreement Change of Name
- Other _____

Execution Date(s): 10-Jul-2004

4. Application number(s) or patent number(s):

If being filed together with a new application, the execution date of application is: 20-Oct-2005

A. Patent Application No.: _____

B. Patent No.: NONE

Additional numbers attached? Yes No

10/554067

5. Name & address to whom correspondence concerning document should be mailed:

Philips Electronics North America Corp.
Intellectual Property & Standards
1109 McKay Drive, M/S-41SJ
San Jose, California 95131

Customer Number:

24738

PATENT TRADEMARK OFFICE

6. Total number of applications and patents involved: 1

7. Total fee (37 DFR 3.41) \$ 40.00

- Enclosed
- Authorized to be charged to deposit account

8. Deposit account number: 14-1270

(Duplicate copy of this page is attached)

9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Peter Zawilski

Peter Zawilski, Reg. No. 43,305

Date 20-OCT-2005


Total number of pages including cover sheet, attachments, and documents: 2

For good and valuable consideration, of which I acknowledge receipt, I, as a below-named assignor, sell and assign to Koninklijke Philips Electronics N.V. (hereinafter "Assignee") a corporation existing under the laws of the Kingdom of the Netherlands, whose business address is Groenewoudseweg 1, 5621 BA Eindhoven, the Netherlands, its successors and assigns, the application for a United States Patent for the improvements in a Semiconductor device comprising extensions produced from material with a low melting point

invented by me, which application:

- is executed concurrently herewith
- was executed by me/us on
- is Serial No. filed
- is International Application No. ..IB.2005./001.254. filed...16...APRIL...2004

and all rights in and to said application, and all Patents which may be granted therefor, and all divisions, reissues, continuations and extensions thereof, and authorize and request the Commissioner of Patents and Trademarks to issue all Patents on said improvements or resulting therefrom to said Assignee as assignee of the entire interest and covenant that I have full right so to do, and agree that I will communicate to said Assignee or its representatives any facts known to me respecting said improvements and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing and reissue applications, make all rightful oaths and generally do everything possible to aid said Assignee, its successors, assigns and nominees, to obtain and enforce proper protection for said invention.

10 JULY 2004 (sign name here)  , Assignor
Date (print name here) Rebha EL-FARHANE